





an Open Access Journal by MDPI

Controllable Preparation and Application of Metal Compounds

Guest Editors:

Dr. Xiaowei Zhang

Institute of Advanced Materials, Beijing Normal University, Beijing, China

Dr. Hongyi Gao

School of Materials Science and Engineering, University of Science and Technology Beijing, Beijing 100083, China

Deadline for manuscript submissions:

closed (15 April 2024)

Message from the Guest Editors

This special issue on "Controllable Preparation and Application of Metal compounds" aims to gather the important developments related to this rapidly growing fields of metal compounds, such as the structural design and precise preparation methods of metal compounds, defect and interface engineering, cost-effective material synthesis techniques, as well as the applications of metal compounds in catalysis, batteries, detectors, ceramics and other fields.











an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Giancarlo Cravotto

Department of Drug Science and Technology, University of Turin, Via P. Giuria 9, 10125 Turin, Italy

Message from the Editor-in-Chief

You are invited to contribute either a research article or a comprehensive review for consideration and publication in *Processes* (ISSN 2227-9717). *Processes* is published in open access format – research articles, reviews, and other content are released on the internet immediately after acceptance. The scientific community and the general public have unlimited, free access to the content. As an open access journal, *Processes* is supported by the authors and their institutes through the payment of article processing charges (APCs) for accepted papers. We would be pleased to welcome you as one of our authors.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus,

SCIE (Web of Science), Ei Compendex, Inspec, AGRIS, and other databases.

Journal Rank: JCR - Q2 (*Engineering, Chemical*) / CiteScore - Q2 (*Chemical Engineering (miscellaneous*))

Contact Us